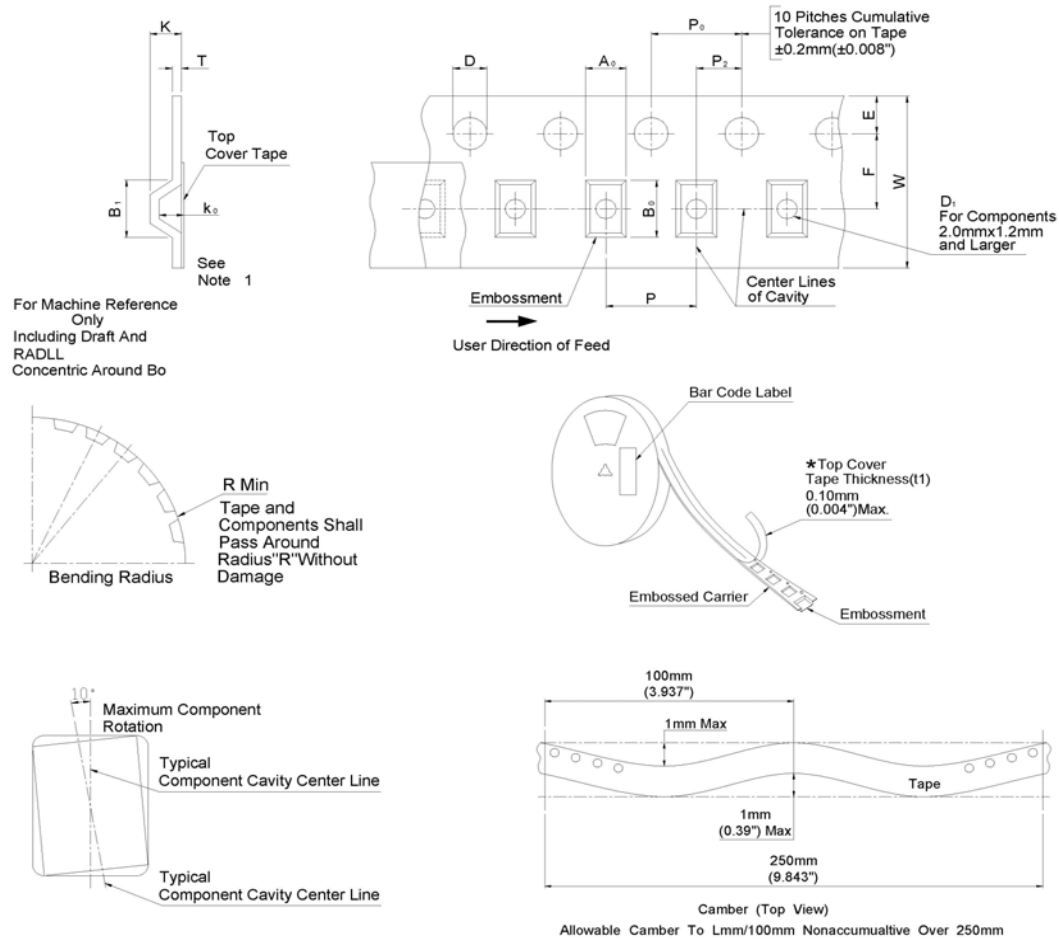


Embossed Tape and Reel Data for Surface Mount Transistors Carrier Tape Specifications



Dimensions

Tape Size	B1 Max.	D	D1	E	F	K	P0	P2	R Min.	T Max.	W Max.
8 mm	4.55 mm (0.179")	1.5 +0.1 mm -0.0	1.0 Min (0.039")	1.75 ± 0.1 mm (0.069 ± 0.004")	3.5 ± 0.05 mm (0.138 ± 0.002")	2.4 mm Max (0.094")	4.0 ± 0.1 mm (0.157 ± 0.004")	2.0 ± 0.1 mm (0.079 ± 0.002")	25 mm (0.98")	0.6 mm (0.024")	8.3 mm (0.327")

Metric dimensions govern-English are in parentheses for reference only.

Note 1: A₀, B₀, and K₀ are determined by component size. The clearance between the components and the cavity must be within 0.05 mm min. to 0.50 mm max.

The component cannot rotate more than 10° within the determined cavity.

If B₁ exceeds 4.2 mm (0.165") for 8 mm embossed tape, the tape may not feed through all tape feeders.